L Number	Hits	Search Text	DB	Time stamp
1	79111	356/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:04
2	5655	356/$.ccls. and planar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:05
3	5863	356/$.ccls. and planar$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:05
4	994	(356/$.ccls. and planar$5) and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:05
5	808	((356/$.ccls. and planar$5) and wafer) and reflected	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:05
6	282	(((356/$.ccls. and planar$5) and wafer) and reflected) and analyzing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:06
7	96	((((356/$.ccls. and planar$5) and wafer) and reflected) and analyzing) and refractive adj3 index$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:06
8	49	(((((356/$.ccls. and planar$5) and wafer) and reflected) and analyzing) and refractive adj3 index$2) and reduction	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 15:07